

**$V_{RSM}$**  = 3000 V  
 **$I_{F(AV)M}$**  = 1285 A  
 **$I_{F(RMS)}$**  = 2019 A  
 **$I_{FSM}$**  =  $15 \times 10^3$  A  
 **$V_{FO}$**  = 0.933 V  
 **$r_F$**  = 0.242 mW

# Rectifier Diode

## 5SDD 11D2800

Doc. No. 5SYA1166-00 Okt. 03

- Very low on-state losses
- Optimum power handling capability

### Blocking

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	$f = 50 \text{ Hz}, t_p = 10\text{ms}, T_j = -40 \dots 160^\circ\text{C}$	2800	V
Non-repetitive peak reverse voltage	$V_{RSM}$	$f = 5 \text{ Hz}, t_p = 10\text{ms}, T_j = -40 \dots 160^\circ\text{C}$	3000	V

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. (reverse) leakage current	$I_{RRM}$	$V_{RRM}, T_j = 160^\circ\text{C}$			30	mA

### Mechanical data

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	$F_M$		8	10	12	kN
Acceleration	a	Device unclamped			50	$\text{m/s}^2$
Acceleration	a	Device clamped			100	$\text{m/s}^2$

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m			0.3		kg
Housing thickness	H	$F_M = 10 \text{ kN}, T_a = 25^\circ\text{C}$	25.5		26.5	mm
Surface creepage distance	$D_S$		33			mm
Air strike distance	$D_a$		18			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

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## On-state

*Maximum rated values<sup>1)</sup>*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	$I_{F(AV)M}$	50 Hz, Half sine wave, $T_C = 85^\circ C$			1285	A
Max. RMS on-state current	$I_{F(RMS)}$				2019	A
Max. peak non-repetitive surge current	$I_{FSM}$	$t_p = 10 \text{ ms}, T_j = 160^\circ C, V_R = 0 \text{ V}$			$15 \times 10^3$	A
Limiting load integral	$I^2t$				$1.125 \times 10^6$	$\text{A}^2\text{s}$
Max. peak non-repetitive surge current	$I_{FSM}$	$t_p = 8.3 \text{ ms}, T_j = 160^\circ C, V_R = 0 \text{ V}$			$16 \times 10^3$	A
Limiting load integral	$I^2t$				$1.066 \times 10^6$	$\text{A}^2\text{s}$

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	$V_F$	$I_F = 1500 \text{ A}, T_j = 160^\circ C$			1.3	V
Threshold voltage	$V_{(TO)}$	$T_j = 160^\circ C$ $I_T = 1500 \dots 4500 \text{ A}$			0.933	V
Slope resistance	$r_T$				0.242	$\mu\Omega$

## Switching

*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Recovery charge	$Q_{rr}$	$di_F/dt = -30 \text{ A}/\mu\text{s}, V_R = 100 \text{ V}$ $I_{FRM} = 1000 \text{ A}, T_j = 160^\circ C$		2200	3000	$\mu\text{As}$

## Thermal

**Maximum rated values<sup>1)</sup>**

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T <sub>vj</sub>		-40		160	°C
Storage temperature range	T <sub>stg</sub>		-40		175	°C

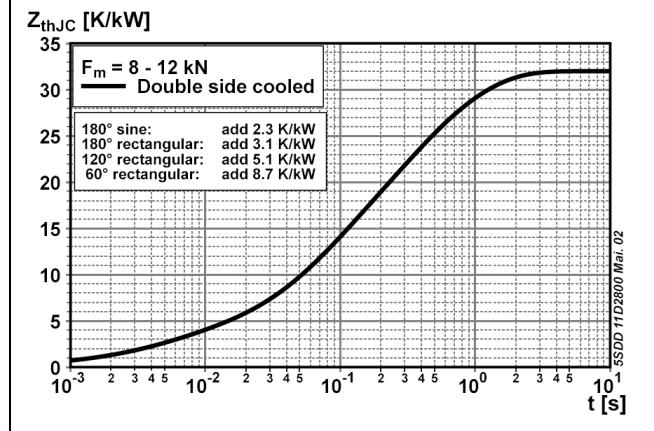
**Characteristic values**

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	R <sub>th(j-c)</sub>	Double-side cooled F <sub>m</sub> = 8...12 kN			32	K/kW
	R <sub>th(j-c)A</sub>	Anode-side cooled F <sub>m</sub> = 8...12 kN			50	K/kW
	R <sub>th(j-c)C</sub>	Cathode-side cooled F <sub>m</sub> = 8...12 kN			88	K/kW
Thermal resistance case to heatsink	R <sub>th(c-h)</sub>	Double-side cooled F <sub>m</sub> = 8...12 kN			8	K/kW
	R <sub>th(c-h)</sub>	Single-side cooled F <sub>m</sub> = 8...12 kN			16	K/kW

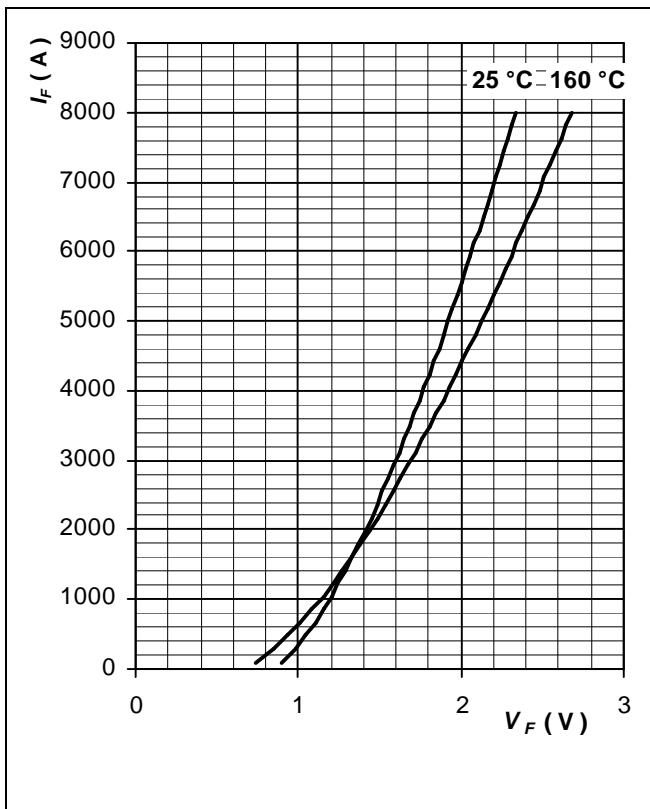
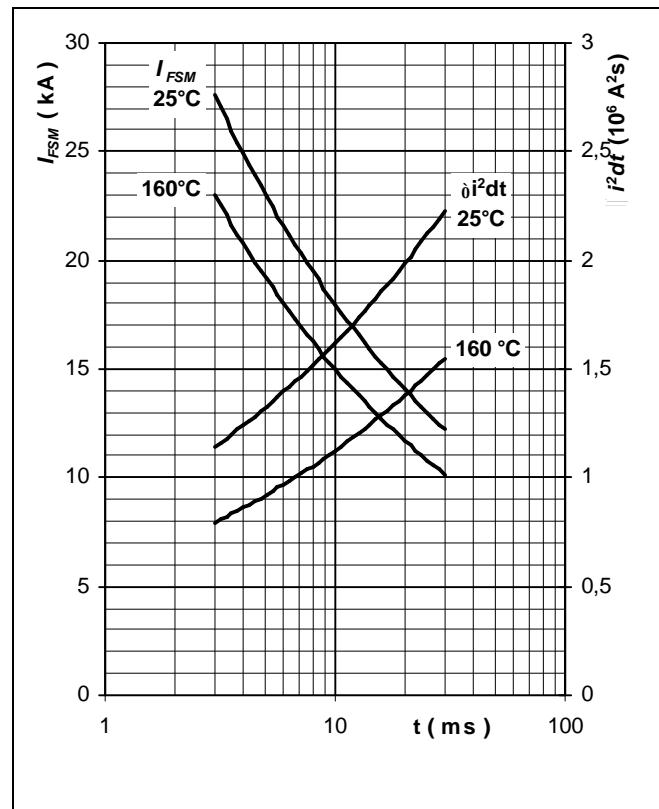
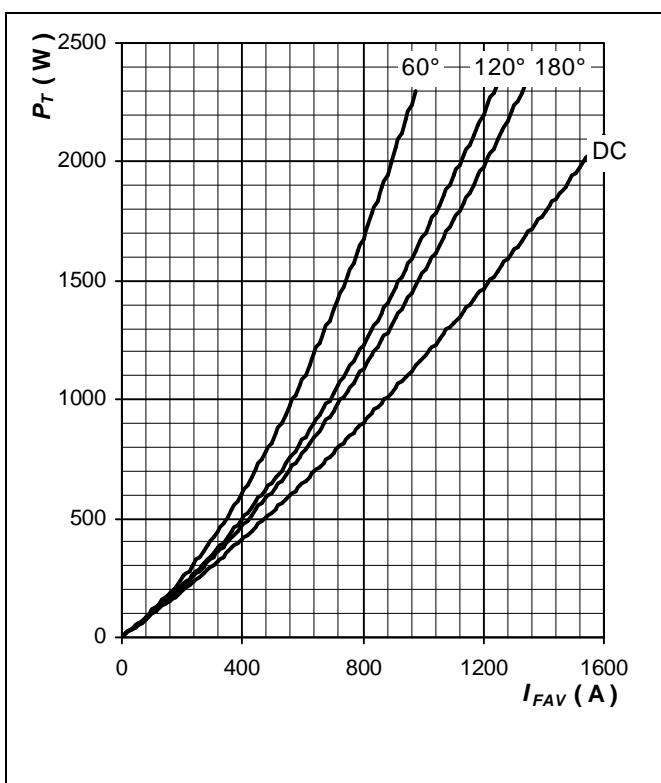
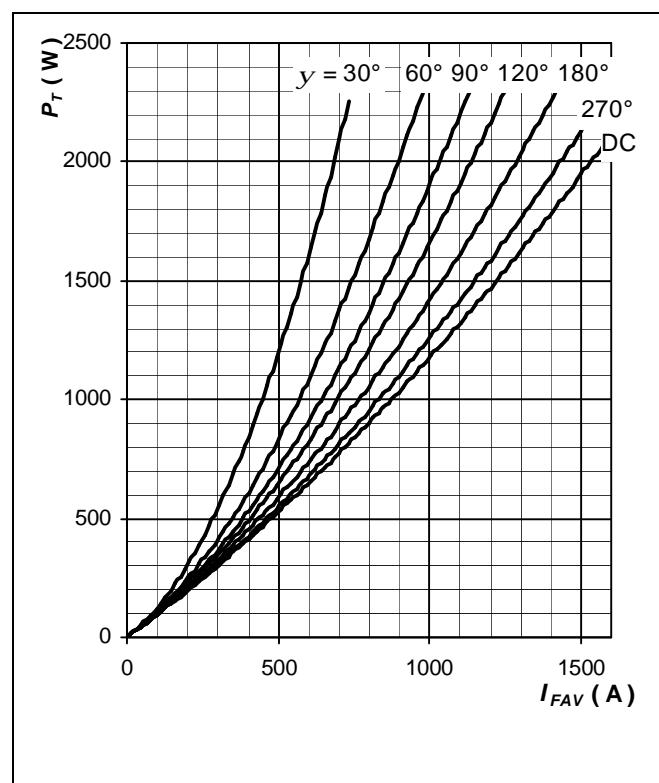
**Analytical function for transient thermal impedance:**

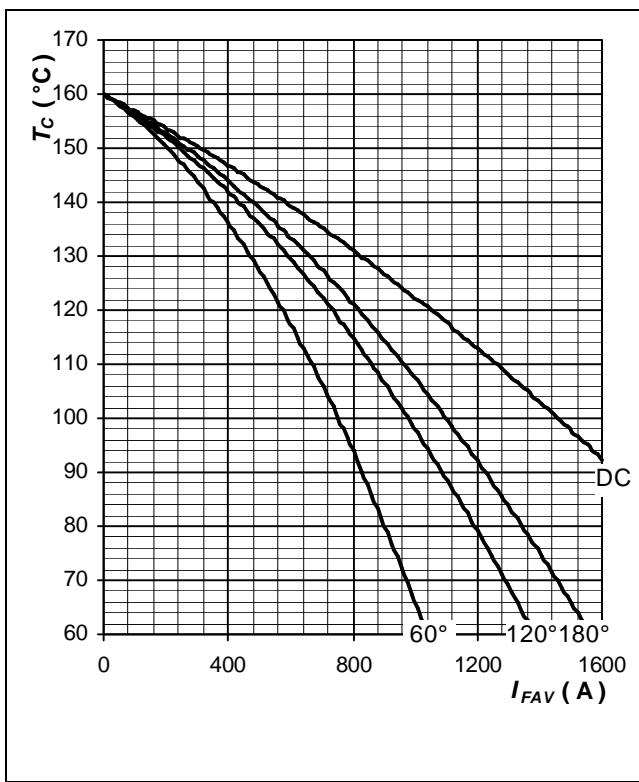
$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_{th i} (1 - e^{-t/\tau_i})$$

i	1	2	3	4
R <sub>th i</sub> (K/kW)	11.600	10.110	7.870	2.410
τ <sub>i</sub> (s)	0.7033	0.2185	0.0588	0.0042

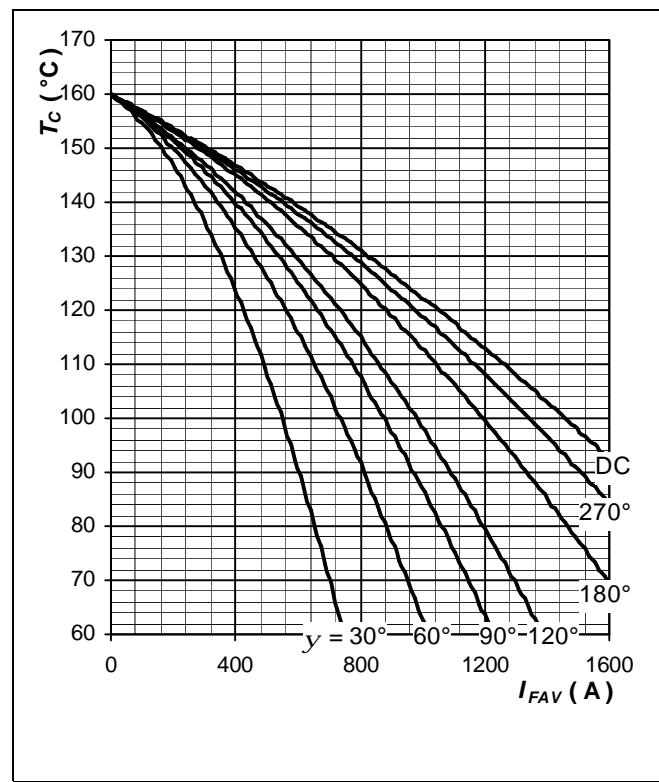


**Fig. 1** Transient thermal impedance junction-to-case.

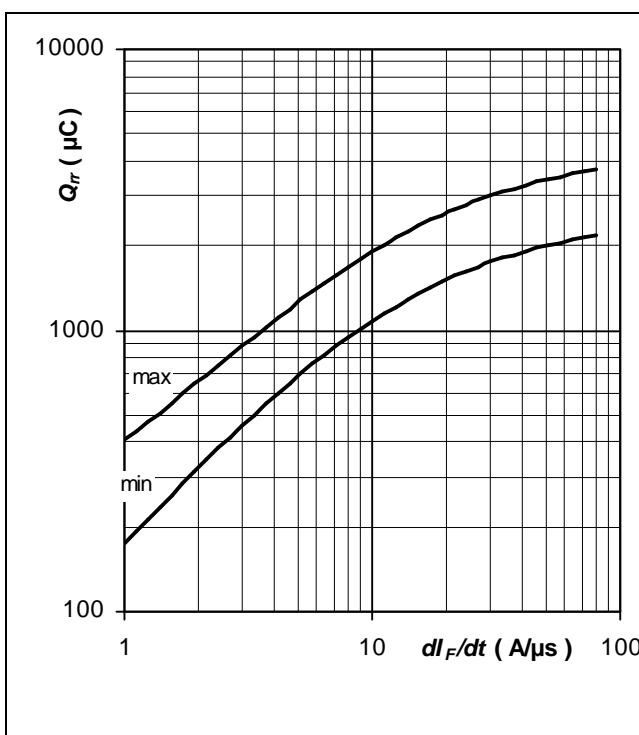
**Fig. 2** Max. on-state characteristics.**Fig. 3** Surge forward current vs. pulse length. Half sine wave, single pulse,  $V_R = 0$  V**Fig. 4** Forward power loss vs. average forward current, sine waveform,  $f = 50$  Hz**Fig. 5** Forward power loss vs. average forward current, square waveform,  $f = 50$  Hz



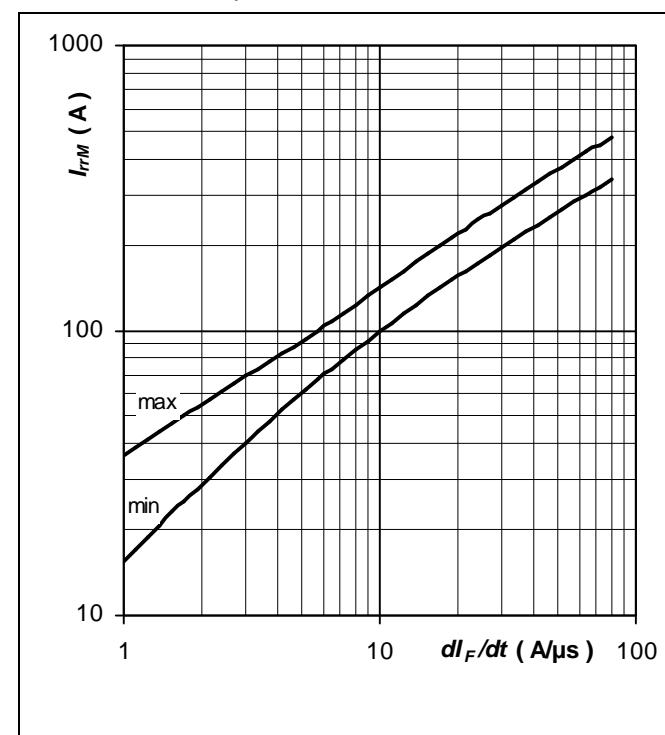
**Fig. 6** Max. case temperature vs aver. forward current, sine waveform,  $f = 50$  Hz



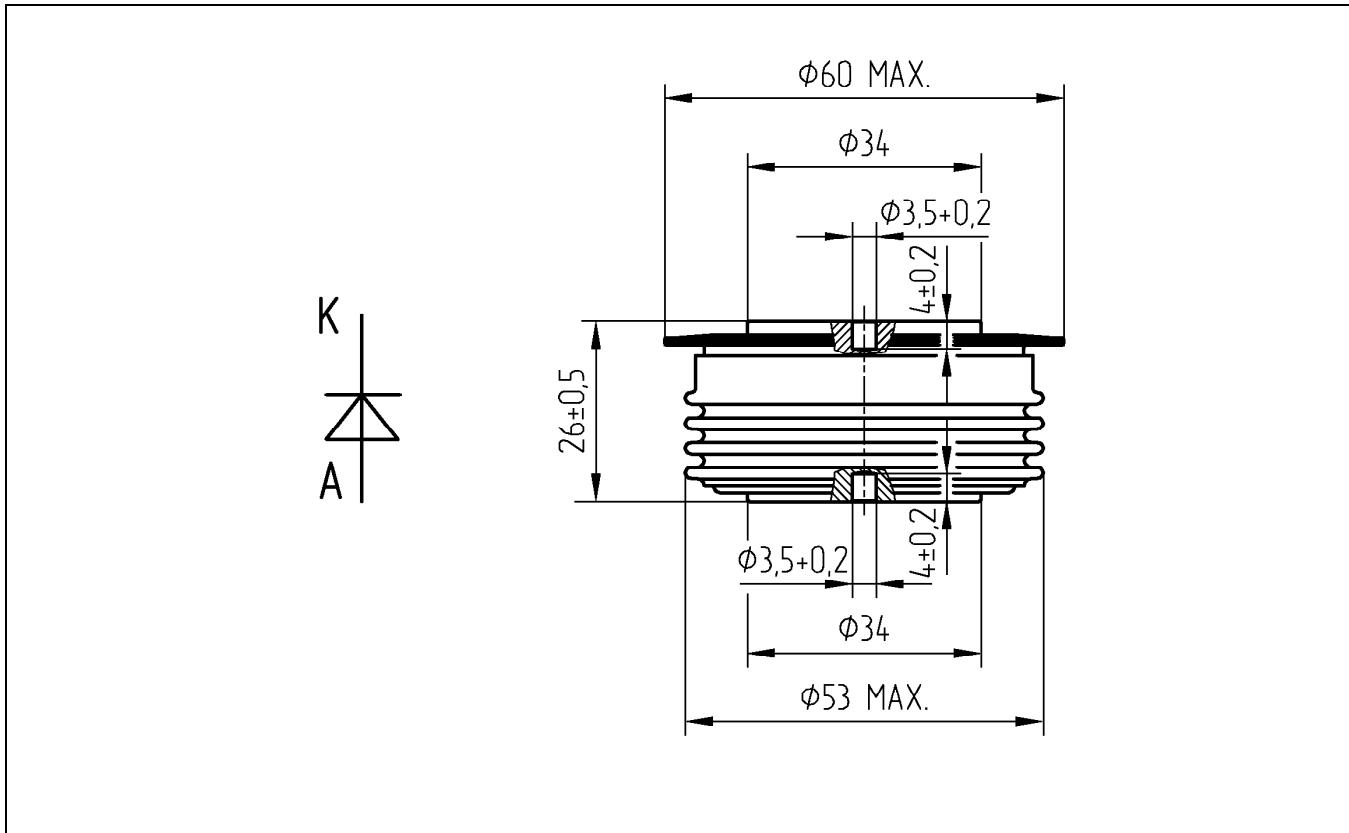
**Fig. 7** Max. case temperature vs aver. forward current, square waveform,  $f = 50$  Hz



**Fig. 8** Reverse recovery charge vs.  $di_F/dt$ ,  $I_F = 1000$  A;  $T_j = T_{j\max}$ , limit values



**Fig. 9** Peak reverse recovery current vs.  $di_F/dt$ ,  $I_F = 1000$  A;  $T_j = T_{j\max}$ , limit values



**Fig. 10** Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

### Related application notes:

Doc. Nr	Titel
5SYA 2020	Design of RC-Snubbers for Phase Control Applications
5SYA 2029	Designing Large Rectifiers with High Power Diodes
5SYA 2036	Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors

Please refer to <http://www.abb.com/semiconductors> for actual versions.

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